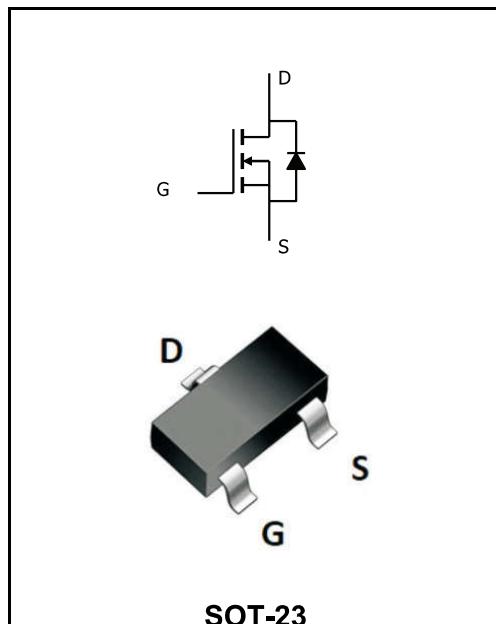


■ N-Channel 30-V (D-S) MOSFET

Features

- $V_{DS} (V) = 30V$
- $R_{DS(ON)} < 57m\Omega$ ($V_{GS} = -10V$)
- $R_{DS(ON)} < 94 m\Omega$ ($V_{GS} = -4.5V$)

Marking Code	
YFW2306	S6

Absolute Maximum Ratings Ta=25°C

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current $T_j=150^\circ C$ *1	Ta=25°C	I_D	3.5	A
	Ta=70°C		2.8	
Pulsed Drain Current		I_{DM}	16	W
Power Dissipation *1	Ta=25°C	P_D	1.25	
	Ta=70°C		0.8	
Thermal Resistance,Junction- to-Ambient	t ≤ 5 sec	R_{thJA}	100	°C/W
	Steady State		130	
Junction Temperature		T_J	150	°C
Storage Temperature Range		T_{stg}	-55 to 150	

*1.Surface Mounted on FR4 Board.,t ≤ 5 sec

Electrical Characteristics Ta=25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-source breakdown voltage	V(BR)DSS	VGS = 0 V, ID = 250 uA	30			V
Gate threshold voltage	VGS(th)	VDS = VGS, ID = 250 uA	1		3	
Gate-body leakage	IGSS	VDS = 0 V, VGS = ± 20 V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 30V, VGS = 0 V			0.5	
		VDS = 30V, VGS = 0 V, TJ = 55 °C			10	uA
On-state drain current	ID(on)	VDS ≥ 4.5 V, VGS = 10 V	6			
		VDS ≥ 4.5 V, VGS = 4.5 V	4			A
Drain-source on-state resistance	rDS(on)	VGS = 10 V, ID = 3.5 A		0.046	0.057	
		VGS = 4.5 V, ID = 2.8 A		0.070	0.094	Ω
Forward transconductance	gfs	VDS = 4.5 V, ID = 3.5 A	6.9			S
Diode forward voltage	VSD	IS = 1.25 A, VGS = 0 V	0.8	1.2		V
gate charge *	Qg	VDS = 15V ,VGS = 5V , ID = 3.5 A	4.2	7		nC
Total gate charge *	Qgt	VDS = 15V ,VGS = 10 V , ID = 3.5 A	8.5	20		
Gate-source charge *	Qgs		1.9			nC
Gate-drain charge *	Qgd		1.35			
Gate Resistance	Rg		0.5		2.4	Ω
Input capacitance *	Ciss	VDS = 15V ,VGS = 0 , f = 1 MHz	555			
Output capacitance *	Coss		120			pF
Reverse transfer capacitance *	Crss		60			
Turn-on time	td(on)	VDD = 15V , RL = 15 Ω, ID = 1A , VGEN = -10V , RG = 6Ω	9	20		
	tr		7.5	18		
Turn-off time	td(off)		17	35		
	tf		5.2	12		ns

* Pulse test: PW ≤ 300 us duty cycle ≤ 2%.

